

Lonten N-channel 100V, 60A, 8.5mΩ Power MOSFET

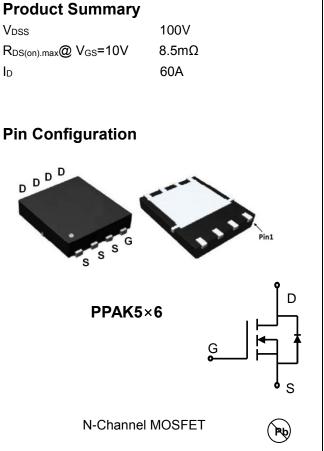
DescriptionProdThese N-Channel enhancement mode power field
effect transistors are using split gate trench DMOS
technology. This advanced technology has been
especially tailored to minimize on-state resistance,
provide superior switching performance, and with
stand high energy pulse in the avalanche and
commutation mode. These devices are well suited
for high efficiency fast switching applications.Prod
VDSS
NDSS

Features

- $100V,60A,R_{DS(ON).max}=8.5m\Omega@V_{GS}=10V$
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green device available

Applications

- Motor Drives
- UPS
- DC-DC Converter



Absolute Maximum Ratings Tc = 25°C unless otherwise noted

Parameter	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	100	V	
Continuous drain current ($T_C = 25^{\circ}C$) ¹⁾		60	A	
Continuous drain current ($T_c = 100^{\circ}C$) ¹⁾	ID	47	А	
Pulsed drain current ²⁾	I _{DM}	240	А	
Gate-Source voltage	V _{GSS}	±20	V	
Avalanche energy, single pulse 3)	E _{AS}	110	mJ	
Power Dissipation ($T_c = 25^{\circ}C$)	P _D	96	W	
Storage Temperature Range	T _{STG}	-55 to +150	°C	
Operating Junction Temperature Range	TJ	-55 to +150	°C	

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{ extsf{ heta}JC}$	1.3	°C/W



Package Marking and Ordering Information

Device	Device Package	Marking
LSGN10R085W3	PPAK5×6	SGN10R085W3

Electrical Characteristics T_J = 25°C unless otherwise noted

Parameter	Symbol	Symbol Test Condition Min.		Тур.	Max.	Unit
Static characteristics	1					1
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =250uA	100			V
Gate threshold voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250$ uA	1.4	1.8	2.2	V
Drain-source leakage current	I _{DSS}	V_{DS} =100V, V_{GS} =0V, T_{J} = 25°C			1	μA
		V _{DS} =80V, V _{GS} =0V, T _J = 125°C			10	μA
Gate leakage current, Forward	I _{GSSF}	V _{GS} =20 V, V _{DS} =0 V			100	nA
Gate leakage current, Reverse	I _{GSSR}	V _{GS} =-20 V, V _{DS} =0 V			-100	nA
Drain-source on-state resistance		V _{GS} =10 V, I _D =30 A		7.0	8.5	mΩ
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =4.5 V, I _D =20 A		8.8	10.5	mΩ
Forward transconductance	g _{fs}	V_{DS} =5V , I_{D} =30A		112		S
Dynamic characteristics						
Input capacitance	C _{iss}			2630		
Output capacitance	C _{oss}	$V_{DS} = 50 V, V_{GS} = 0 V,$		453		pF
Reverse transfer capacitance	C _{rss}	F = 1MHz		36		
Turn-on delay time	t _{d(on)}			10.5		
Rise time	t _r			63		ns
Turn-off delay time	t _{d(off)}	$V_{DD} = 50V, V_{GS} = 10V, I_D = 30A$		30		
Fall time	t _f			96		
Gate resistance	R _g	V _{GS} =0V, V _{DS} =0V, F=1MHz		1.1		Ω
Gate charge characteristics		•				
Gate to source charge	Q _{gs}			10.2		
Gate to drain charge	Q _{gd}	$V_{DS}=50 V, I_{D}=50A,$		6.6		nC
Gate charge total	Qg	V _{GS} = 10 V		45		_
Drain-Source diode characteris	tics and Maxi	mum Ratings				•
Continuous Source Current	Is				60	А
Pulsed Source Current	I _{SM}	$V_G = V_D = 0 V$, Force Current			240	А
Diode Forward Voltage4)	V _{SD}	V _{GS} =0V, I _S =30A, T _J =25℃			1.3	V
Reverse Recovery Time	t _{rr}	I _S =30A, di/dt=100A/us,		65		ns
Reverse Recovery Charge	Q _{rr}	T 」=25 ℃		104		nC

Notes:

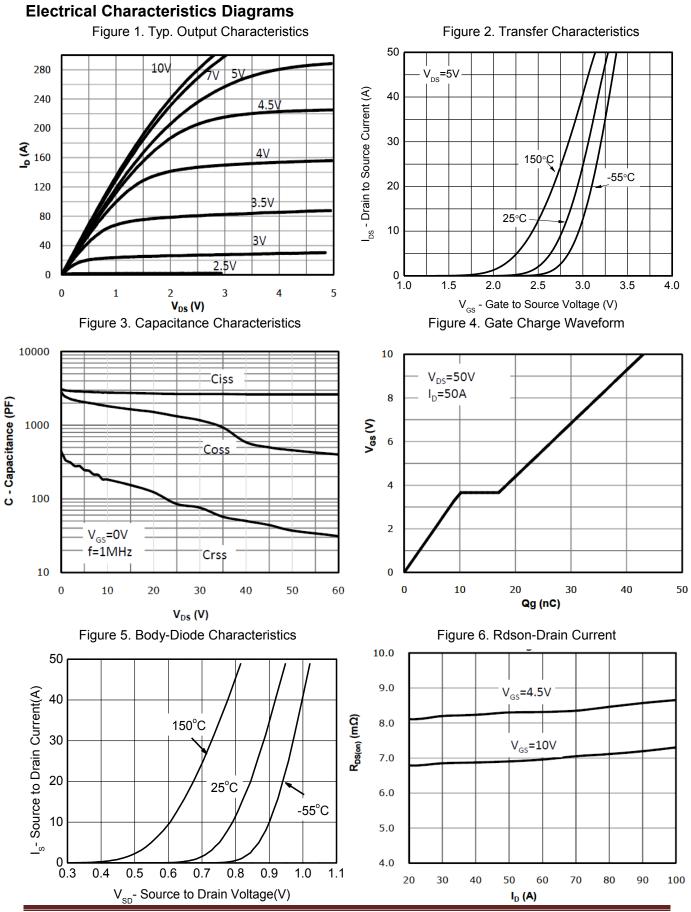
1: The maximum junction current rating is package limited.

2: Repetitive Rating: Pulse width limited by maximum junction temperature.

3: V_DD=50V, V_Gs=10V, L=0.5mH, I_{AS}=21A, R_G=25\Omega, Starting T_J=25 $^\circ\!\mathrm{C}.$

4: Pulse Test: Pulse Width $\leq 300 \,\mu \,s$, Duty Cycle $\leq 2\%$.







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LSGN10R085W3

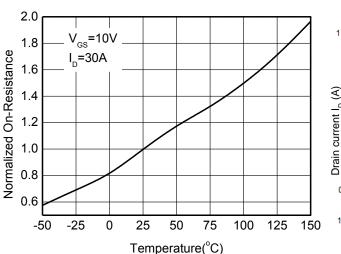


Figure 7. Rdson-Junction Temperature (°C)

++++ 1000 * ----us -100 Drain current I_D (A) 10 DC 0.1 П Notes $T_c = 25^{\circ}C$ 0.0 T = 150°C Single Pulse 1E-3 Drain-Source Voltage V_{DS} (V) 0.1 100

Figure 8. Maximum Safe Operating Area

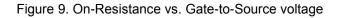
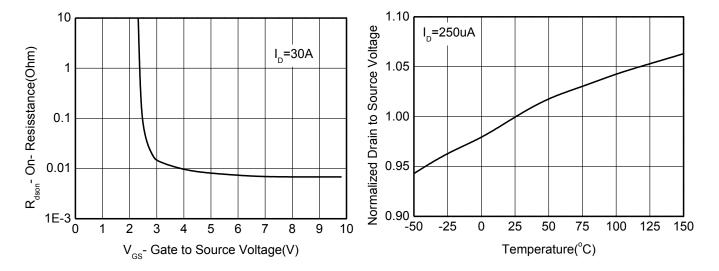
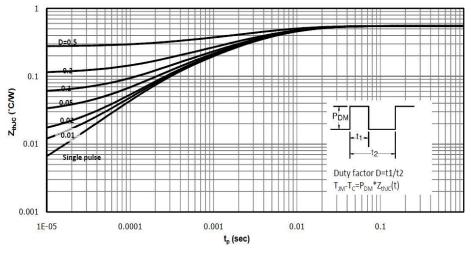


Figure 10. BVdss vs. Junction temperature



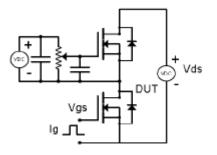






Test Circuit & Waveform

Figure 8. Gate Charge Test Circuit & Waveform



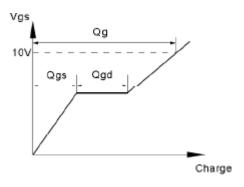


Figure 9. Resistive Switching Test Circuit & Waveforms

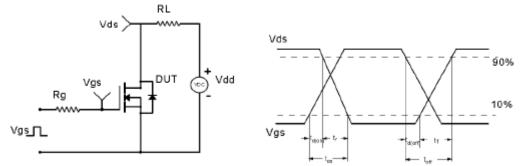
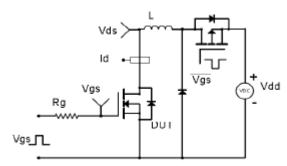


Figure 10. Unclamped Inductive Switching (UIS) Test Circuit & Waveform



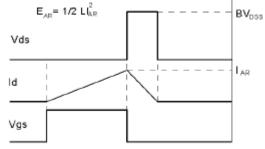
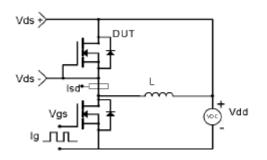
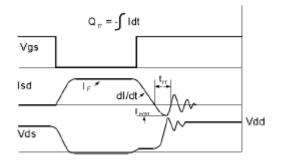


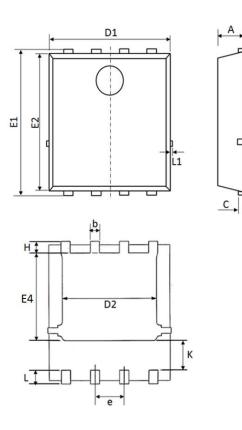
Figure 11. Diode Recovery Circuit & Waveform





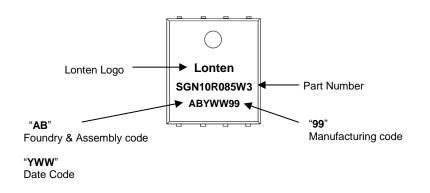


Mechanical Dimensions for PPAK5×6



COMMON DIMENSIONS						
OVMDOL	MILLIMETERS			INCHS		
SYMBOL	MIN	NOM	MAX	MIN	NOM	MAX
A	1	1.1	1.2	0.039	0.043	0.047
b	0.3	0.4	0.5	0.012	0.016	0.020
С	0.154	0.254	0.354	0.006	0.010	0.014
D1	5	5.2	5.4	0.197	0.205	0.213
D2	3.8	4.1	4.25	0.150	0.161	0.167
E1	5.95	6.15	6.35	0.234	0.242	0.250
E2	5.66	5.86	6.06	0.223	0.231	0.239
E4	3.52	3.72	3.92	0.139	0.146	0.154
е	1.27 BSC			0.050 BSC		
н	0.4	0.5	0.6	0.016	0.020	0.024
L	0.5	0.6	0.7	0.020	0.024	0.028
L1	-	-	0.12	-	-	0.005
к	1.14	1.29	1.44	0.045	0.051	0.057

PPAK5×6 Part Marking Information







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